

The following specification are standard for normal production of Printed Circuit Board .
For special requirement se PCBSPEC.TXT sh. 112-3

DK-AUDIO A/S
MARIELUNDVEJ 37D
DK - 2730 HERLEV DENMARK

STANDARD SPECIFICATION FOR PRINTED CIRCUIT BOARD	
SPECIFICATION	ACCORDING TO THE LATEST VERSION OF PERFAG 2, 3 & 10
LAMINATE	TYPE : FR4 THICKNESS : 1.6 mm
LAYER BUILD-UP	ACCORDING TO 4008 108 0490 OR 4008 108 04910
COPPER FOIL	THICKNESS : 35µ
PROTECTIVE COATING	TYPE : SOLDER COATING & HOT-AIR LEVELLING
SOLDER MASK	TYPE : - XV501T & XV501TM SCREEN IMAGECURE - PETERS, SD2461 SM-DG, DARK-GREEN - PRINTED CIRCUIT RESIST, PSR-4000 MATERIAL: LIQUID FILM
COMPONENT MASK	TYPE : - XV501T & XV501TM SCREEN IMAGECURE - PETERS, SD2461 SM-DG, DARK-GREEN - PRINTED CIRCUIT RESIST, PSR-4000 MATERIAL: LIQUID FILM
MARKING	COMPONENT NOTATION ON COMPONENT SIDE : MANUFACTURE STANDARD COLOUR LOGO & DATE (MM/YY) OF PCB MANUFACTURE : SEE "LOGO & DATE" IN HOLE SCHEDULE & MECH. DRAWING

CLASS NO.		STANDARD SPECIFICATION FOR PRINTED CIRCUIT BOARD		4008 108 04930		1	97-10-29		
						2	2003-11-28		
NAME: NAVN:	JML / SMa/GBG	SUPERS. ERST.	1	SH BL	SH BL	1 OF 1		KU	FORM A4
P-DOC	CHECK:	DATE:03-11-28	DK-AUDIO A/S – MARIELUNDVEJ 37D - DK 2730 HERLEV - DENMARK						